

S/N 09/775,370

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

Applicant: Zheng et al. Examiner: Andujar, L.
Serial No.: 09/775,370 Group Art Unit: 2826
Filed: February 1, 2001 Docket No.: New: PHA 51108A
Old: VLSI.225DIV1
Title: OPTIMIZED METAL ETCH PROCESS TO ENABLE THE USE OF
ALUMINUM PLUGS

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this communication is being deposited in the United States Postal Service, as first class mail, in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on January 13, 2002.

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